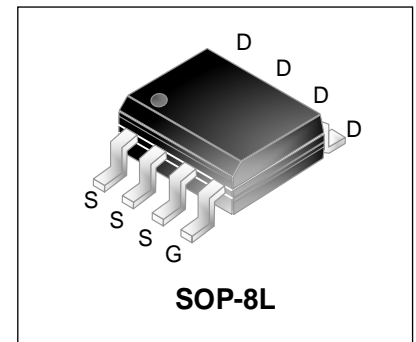


65V N-Channel Enhancement Mode Power MOSFET

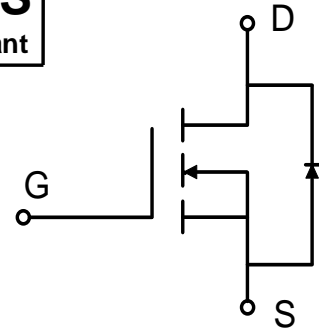
Description

WMS048NV6LG2 uses Wayon's 2nd generation POWER TRENCH MOSFET technology that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance. This device is well suited for high efficiency fast switching applications.



Features

- $V_{DS} = 65V$, $I_D = 17.5A$ (Silicon Limited)
 $R_{DS(on)} < 5.5m\Omega$ @ $V_{GS} = 10V$
 $R_{DS(on)} < 7.6m\Omega$ @ $V_{GS} = 4.5V$
- High Speed Power Switching
- Low Gate Charge
- Low $R_{DS(ON)}$
- 100% EAS Guaranteed



Applications

- Synchronous Rectification in SMPS
- Hard Switching and High Speed Circuit
- DC/DC Converter

Absolute Maximum Ratings

Parameter		Symbol	Value	Unit
Drain-Source voltage		V_{DS}	65	V
Gate-Source voltage		V_{GS}	± 20	V
Continuous Drain Current@10V ¹	$T_C = 25^\circ C$	I_D	17.5	A
	$T_C = 100^\circ C$		10.9	
Continuous Drain Current ¹ (Package Limited)	$T_C = 25^\circ C$		35	
Pulsed Drain Current ²		I_{DM}	181	A
Single Pulse Avalanche Energy ³		EAS	26.5	mJ
Avalanche Current		I_{AS}	23	A
Total Power Dissipation ⁴	$T_C = 25^\circ C$	P_D	3.1	W
Operating Junction and Storage Temperature Range		T_J, T_{STG}	-55 to 150	$^\circ C$

Thermal Characteristics

Parameter	Symbol	Value	Unit
Thermal Resistance from Junction-to-Ambient ¹	$R_{\theta JA}$	73	$^\circ C/W$
Thermal Resistance from Junction-to-Lead ¹	$R_{\theta JL}$	24.3	

Electrical Characteristics $T_c = 25^\circ\text{C}$, unless otherwise noted

Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit	
Static Characteristics							
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	65	-	-	V	
Gate-body Leakage current	I_{GSS}	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	± 100	nA	
Zero Gate Voltage Drain Current	$T_J=25^\circ\text{C}$	I_{DSS}	$V_{DS} = 60V, V_{GS} = 0V$	-	-	1	μA
	$T_J=100^\circ\text{C}$			-	-	100	
Gate-Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	1.0	1.6	2.4	V	
Drain-Source On-Resistance ²	$R_{DS(on)}$	$V_{GS} = 10V, I_D = 20A$	-	4.2	5.5	m Ω	
		$V_{GS} = 4.5V, I_D = 10A$	-	6.2	7.6		
Forward Transconductance	g_{fs}	$V_{DS} = 5V, I_D = 20A$	-	58	-	S	
Dynamic Characteristics							
Input Capacitance	C_{iss}	$V_{DS} = 30V, V_{GS} = 0V, f = 1\text{MHz}$	-	1900	-	pF	
Output Capacitance	C_{oss}		-	785	-		
Reverse Transfer Capacitance	C_{rss}		-	50	-		
Switching Characteristics							
Gate Resistance	R_g	$V_{DS}=0V, V_{GS}=0V, f=1\text{MHz}$	-	1.33	-	Ω	
Total Gate Charge	Q_g	$V_{GS} = 4.5V, V_{DD} = 30V, I_D = 20A$	-	24	-		
Total Gate Charge	Q_g	$V_{GS} = 10V, V_{DD} = 30V, I_D = 20A$	-	39	-	nC	
Gate-Source Charge	Q_{gs}		-	4.3	-		
Gate-Drain Charge	Q_{gd}		-	10.5	-		
Turn-On Delay Time	$t_{d(on)}$	$V_{GS} = 10V, V_{DD} = 30V, R_G = 10\Omega, I_D = 20A$	-	9.6	-	nS	
Rise Time	t_r		-	7.6	-		
Turn-Off Delay Time	$t_{d(off)}$		-	32.5	-		
Fall Time	t_f		-	9.6	-		
Drain-Source Body Diode Characteristics							
Diode Forward Voltage ²	V_{SD}	$I_S = 30A, V_{GS} = 0V$	-	0.9	1.2	V	
Body Diode Reverse Recovery Time	t_{rr}	$V_R = 30V, I_F = 20A, di/dt = 400A/\mu s$	-	29.1	-	nS	
Body Diode Reverse Recovery Charge	Q_{rr}		-	66	-	nC	

Notes:

1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
2. The data tested by pulsed, pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$
3. The EAS data shows Max. rating. The test condition is $V_{DD}=25V, V_{GS}=10V, L=0.1\text{mH}, I_{AS}=23A$
4. The power dissipation is limited by 150°C junction temperature

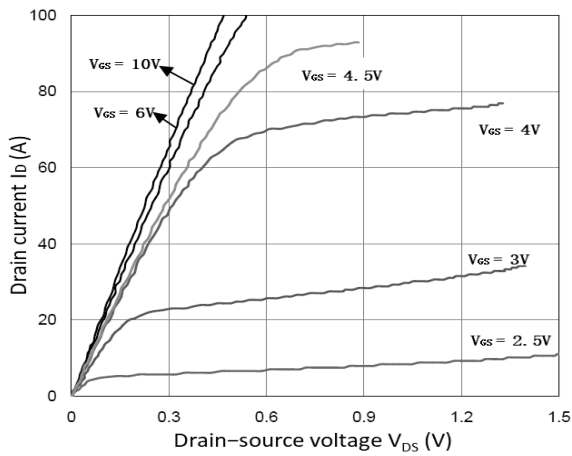


Figure 1. Output Characteristics

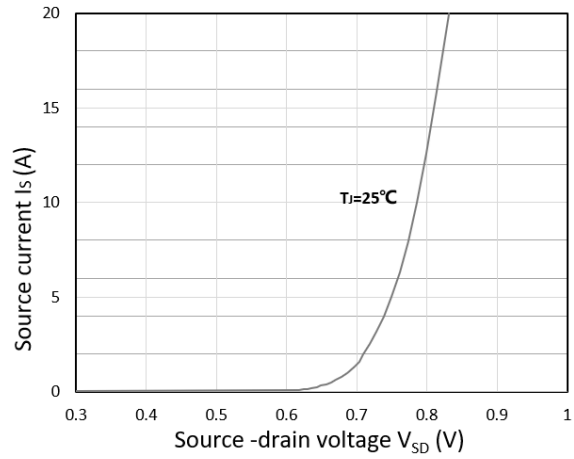


Figure 2. Forward Characteristics of Reverse

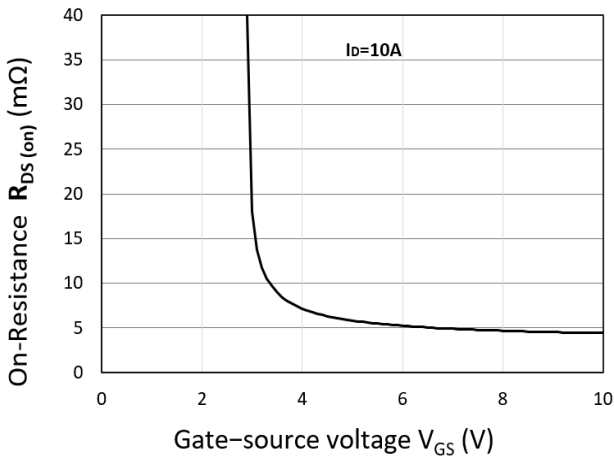


Figure 3. $R_{DS(ON)}$ vs. V_{GS}

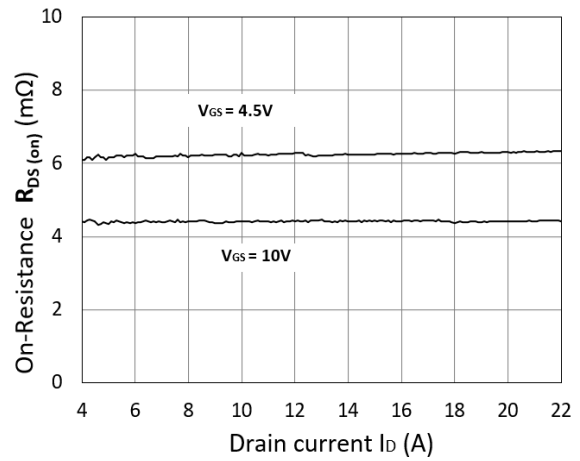


Figure 4. $R_{DS(ON)}$ vs. I_D

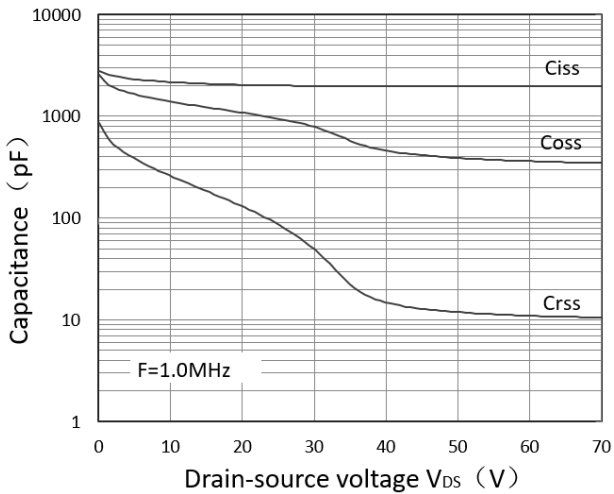


Figure 5. Capacitance Characteristics

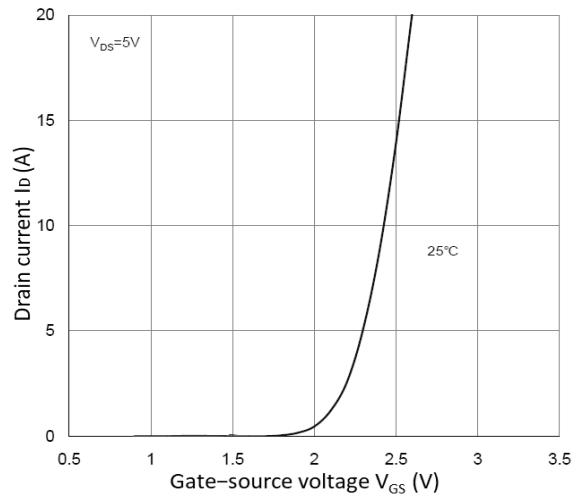


Figure 6. Transfer Characteristics

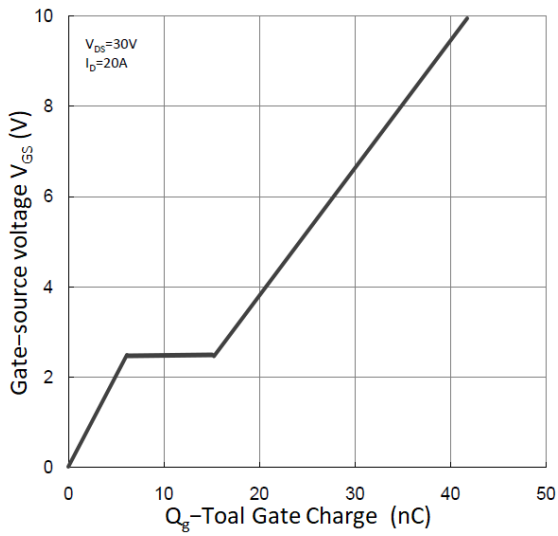


Figure 7. Gate Charge Characteristics

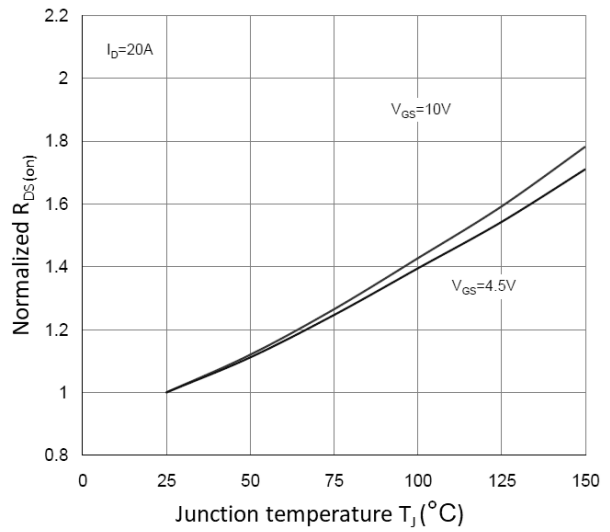


Figure 8. Normalized $R_{DS(on)}$ vs. T_j

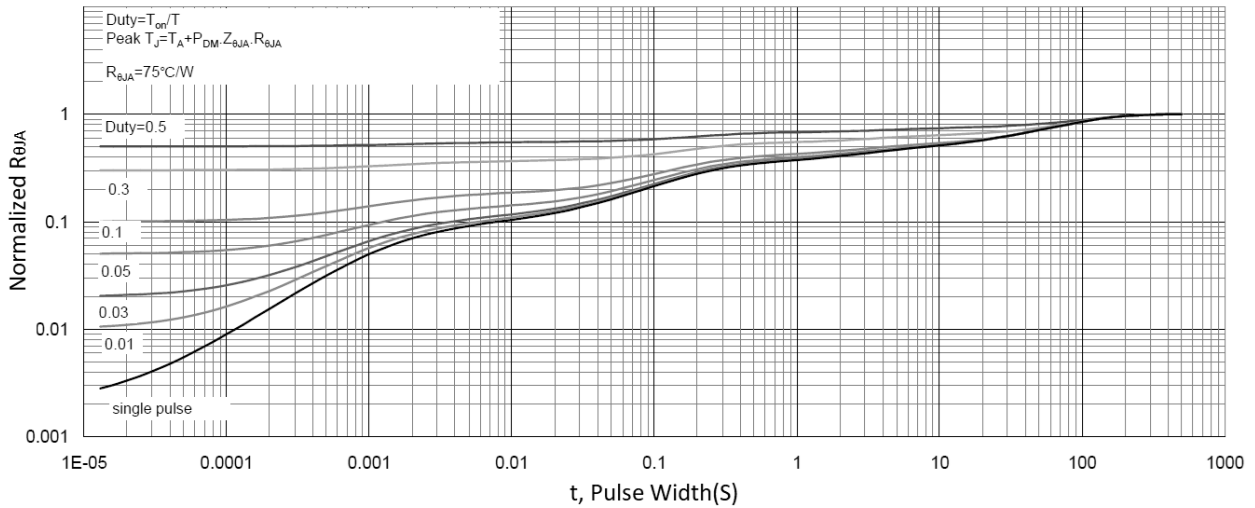


Figure 9. Normalized Maximum Transient Thermal Impedance

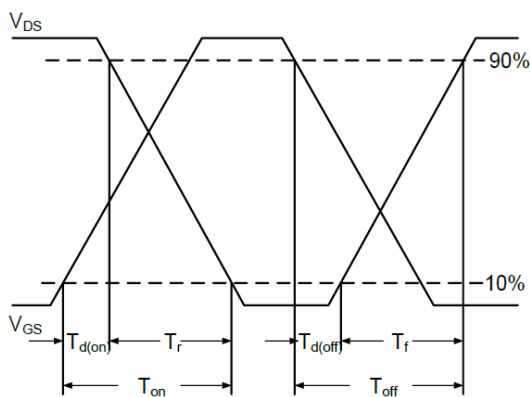


Figure 10. Switching Time Waveform

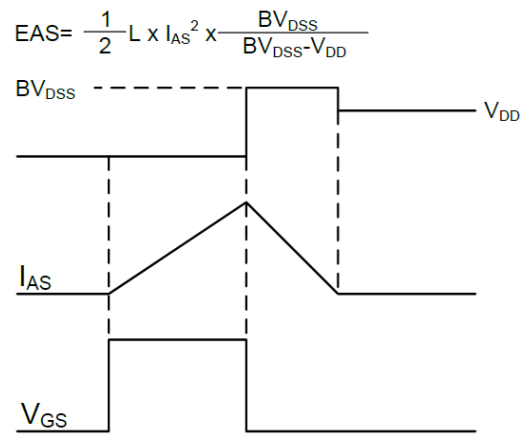
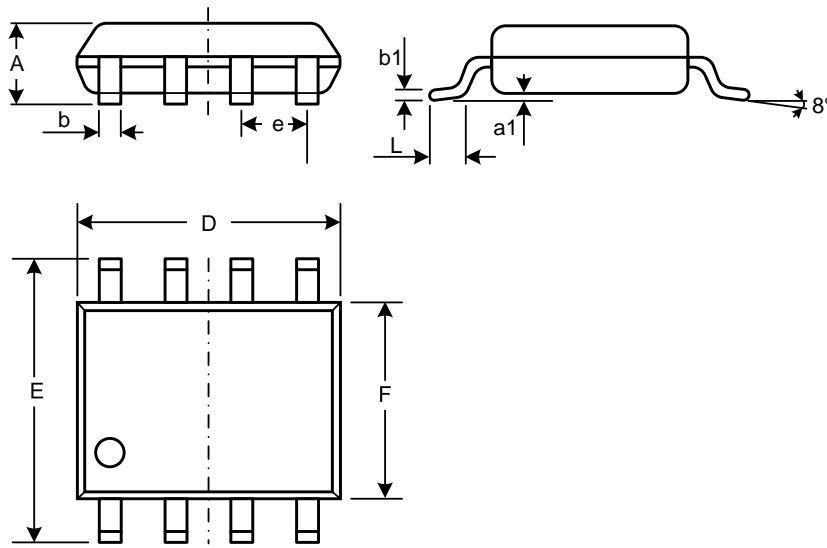


Figure 11. Unclamped Inductive Switching Waveform

$$EAS = \frac{1}{2} L \times I_{AS}^2 \times \frac{BV_{DSS}}{BV_{DSS} - V_{DD}}$$

Mechanical Dimensions for SOP-8L



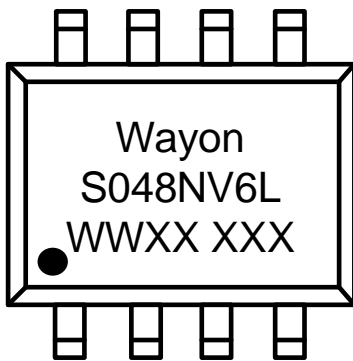
COMMON DIMENSIONS

SYMBOL	MM	
	MIN	MAX
A	1.23	1.75
a1	0.05	0.25
b	0.31	0.51
b1	0.16	0.25
D	4.70	5.15
E	5.75	6.25
e	1.07	1.47
F	3.70	4.10
L	0.4	1.27

Ordering Information

Part	Package	Marking	Packing method
WMS048NV6LG2	SOP-8L	S048NV6L	Tape and Reel

Marking Information



S048NV6L = Device code

WWXX XXX= Date code

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WAYON website: <http://www.way-on.com>

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